### SLIC PROTECTOR



# DESCRIPTION

The PSLIC1 is a programmable transient voltage protector, designed to protect Subscriber Line Interface Circuit (SLIC) cards for xDSL communication ports. The device can be set referenced to -VBAT, through the gate to trigger the thyristor on negative transients, while the other two diodes act as clippers for positive overloads in the circuit. PSLIC1 is configured to ensure reliable protection, eliminating the overvoltage transients introducted by the parasitic inductance of the wiring, in particular for very fast transients. The device is available in an SOIC-8 package.

APPLICATIONS

xDSL Interfaces

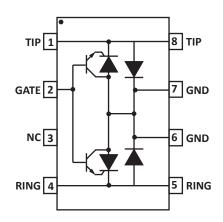
### FEATURES

- Dual Programmable Transient Suppressor
- Wide Negative Firing Voltage Range: V<sub>GKRM</sub> @ -167V Max
- Low Dynamic Switching Voltage:  $V_{FRM} & V_{GK(BD)}$
- Low Gate Trigger Current:  $I_{GT} @ 5mA Max$
- Peak Pulse Current: I<sub>pp</sub> @ 30A for 10/1000μs Surge
- ITU-T-K20/21 (IEC 61000-4-2) Air/Contact ±30kV
- Holding Current: I<sub>µ</sub> @ 150mA Min
- RoHS Compliant
- REACH Compliant

# **MECHANICAL CHARACTERISTICS**

- Molded JEDEC SO-8 Package
- Approximate Weight: 70 milligrams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:
- Pure-Tin Sn, 100: 260-270°C
- 12mm Tape and Reel Per EIA Standard 481
- Flammability Rating UL 94V-0

# **PIN CONFIGURATION**



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MAXIMUM RATINGS @ 25°C Unless Otherwise Specified								
PARAMETER	SYMBOL	VALUE	UNITS					
Storage Temperature	T <sub>stg</sub>	-40 to +150	°C					
Junction Temperature	Tj	-40 to +150	°C					
Ambient Temperature	T <sub>A</sub>	-40 to +150	°C					
		30 @ 10/1000µs						
Non-Repetitive Peak On-State Pulse Current	I <sub>tsp</sub>	40 @ 5/310µs	А					
		100 @ 1.2/50μs						
Non-Repetitive Peak Pulse Voltage - 10/700µs	V <sub>pp</sub>	2000	v					
		6.5 @ 0.5s						
		4.6 @ 1s						
Non-Repetitive Surge Peak On-Current (Sinusoidal) 60Hz	I <sub>TSM</sub>	2.3 @ 5s	А					
		1.3 @ 30s	1					
		0.73 @ 900s	1					
Maximum Voltage - Line/Ground	V <sub>DRM</sub>	-170	V					
Maximum Voltage - Gate/Line	V <sub>GKRM</sub>	-167	v					
Thermal Resistance - Junction to Ambient	R <sub>oja</sub>	150	°C/W					

EL	ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified								
PART NUMBER	DEVICE MARKING	MAXIMUM FORWARD VOLTAGE $I_F @ 5A$ $t_w = 200 \mu s$ $V_F$ VOLTS	MAXIMUM FORWARD RECOVERY VOLTAGE 2/10µs I <sub>F</sub> @ 100A RS = 50 Ohms di/dt = 80A/µs V <sub>F</sub> VOLTS	MAXIMUM OFF-STATE CURRENT V <sub>DRM</sub> @ -170V V <sub>GK</sub> = 0V I <sub>DRM</sub> μΑ	MAXIMUM BREAKOVER VOLTAGE 2/10 $\mu$ s I <sub>TM</sub> @ -100A RS = 50 Ohms di/dt = 80A/ $\mu$ s V <sub>GG</sub> = -100V V <sub>BO</sub> VOLTS				
PSLIC1	PTR1	3	10	-5	-112				

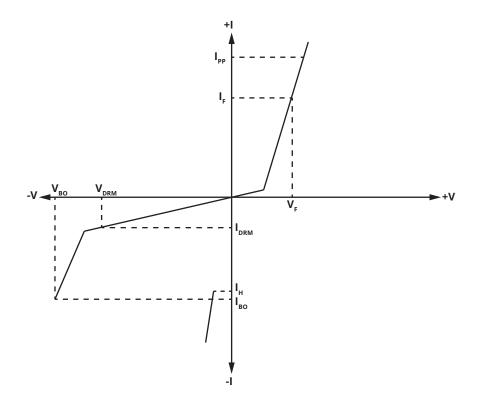
ELECTF	ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified								
$MINIMUMHOLDINGCURRENTI_{T} = -1Adi/dt = 1A/msV_{GG} = -100VI_{H}mA$	MAXIMUM GATE REVERSE CURRENT $V_{GG} = V_{GK} = -167V$ $V_{KA} = 0$ $T_{J} = 25^{\circ}C$ $I_{GKS}$ $\mu A$	MAXIMUM GATE TRIGGER CURRENT I <sub>T</sub> = -3A tp(g)≥20µs V <sub>GG</sub> = -100V I <sub>GT</sub> mA	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	MAXIMUM ANODE-CATHODE OFF-STATE CAPACITANCE f=1MHz, V <sub>D</sub> =1V I <sub>G</sub> =0A, V <sub>D</sub> =-3V C <sub>AK</sub> pF	MAXIMUM ANODE-CATHODE OFF-STATE CAPACITANCE f=1MHz, V <sub>p</sub> =1V I <sub>g</sub> =0A, V <sub>p</sub> =50V C <sub>AK</sub> pF				
-150	-5	5	2.5	70	30				

# TYPICAL DEVICE CHARACTERISTICS

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RECOMMENDED OPERATING CONDITIONS @ 25°C Unless Otherwise Specified									
COMPONENT	SYMBOL	VALUE	UNITS						
Gate Decoupling Capacitor	C <sub>G</sub>	100 Min, 220 Typ.	nF						
Minimum Resistor for GR-1089-CORE First-Level Surge		25							
Minimum Resistor for GR-1089-CORE First-Level & Second-Level Surge Survival	]	40	0						
Minimum Resistor for GR-1089-CORE Intra-Building Port Surge Survival	R <sub>s</sub>	8	Ω						
Minimum Resistor for K.20, K.21 & K.45 Coordination with a 400V Primary Protector	]	10							

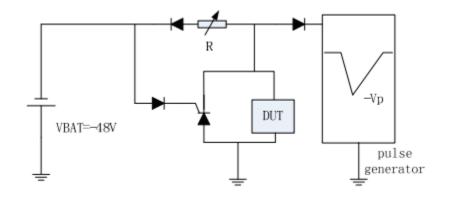
FIGURE 1 VI CHARACTERISITC CURVE



TESTING STANDARDS								
ТҮРЕ	WAVE	SHARP	V <sub>pp</sub> /I <sub>pp</sub>					
	Voltage	10/700µs	2000V					
ITU-T K.20/21 & K.45	Current	5/310µs	40A					
1. The PSLC1 is intended to be used with a series combination of a 40 Ohm or higher resistance and a suitable overcurrent protector. Power fault compliance requires the series overcurrent element to open-circuit or become high impedance. For equipment compliant to ITU-T recommendations, K.20 or K.21 or K.45 only, the series resistor value is set by the coordination requirements. For coordination with a 400V limit GDT, a minimum series resistor value of 10 Ohm is recommended.								

# TYPICAL DEVICE CHARACTERISTICS

### **HOLDING CURRENT - TEST CIRCUIT 1**



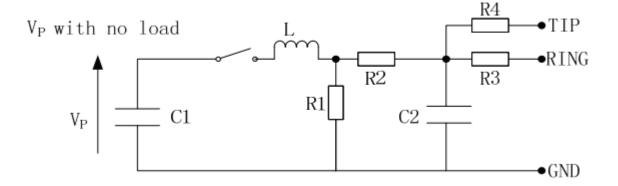
This is a conduction-cutoff test. The test circuit an ascertain the size of holding current. Test method:

1. Short out DUT, regulating current in IH range.

2. Triggering DUT with  $I_{pp}$  = 10A, 10/1000µs surge current.

3. DUT needs to return to the off-state in the maximum 50ms.

# V<sub>FP</sub> AND V<sub>GDL</sub> - TEST CIRCUIT 2



	LSE เร	V.	C1	C2	L	R1	R2	R3	R4	l	R.
Trise	Tfall	V	μF	nF	μН	Ω	Ω	Ω	Ω	рр А	Ω
10	700	1500	20	200	0	50	15	25	25	30	10
1.2	50	1500	1	33	0	76	13	25	25	30	10
2	10	2500	10	0	1.1	1.3	0	3	3	38	62

# **SO-8 PACKAGE INFORMATION**

OUTLINE DIMENSIONS								
DIM	MILLIN	IETERS	INCHES					
DIIVI	MIN	MAX	MIN	MAX				
А	4.80	5.00	0.189	0.196				
В	3.80	4.00	0.150	0.157				
С	1.35	1.75	0.054	0.068				
D	0.35	0.49	0.014	0.019				
F	0.40	1.25	0.016	0.049				
G	1.27	BSC	0.05	BSC				
J	0.18	0.25	0.007	0.009				
К	0.10	0.25	0.004	0.008				
Р	5.80	6.20	0.229	0.244				
R	0.25	0.50	0.010	0.019				



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1. -T- = Seating plane and datum surface.

2. Dimensions "A" and "B" are datum.

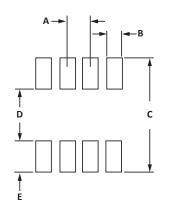
3. Dimensions "A" and "B" do not include mold protrusion.

Maximum mold protrusion is 0.015" (0.380mm) per side.
 Dimensioning and tolerances per ANSI Y14.5M, 1982.

Dimensions are exclusive of mold flash and metal burrs.

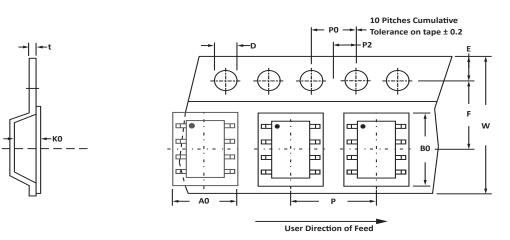
	(+) 0.010″ (0.25mm) M B M 4 PL
G→    ← →    ← D ┌─C	→ R x 45°
(+) 0.010″ (0.25mm) (M)  T  B (S)  A(S) 8 PL	

PAD LAYOUT DIMENSIONS MILLIMETERS INCHES DIM MIN MAX MIN MAX 1.40 0.045 А 1.14 0.055 В 0.64 0.89 0.025 0.035 С 6.22 \_ 0.245 \_ D 0.165 3.94 4.17 0.155 Е 1.02 1.27 0.040 0.050 NOTES 1. Controlling dimension: inches.



### TAPE AND REEL

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SPECIFICATIONS												
REEL DIA.	TAPE WIDTH	A0	В0	ко	D	E	F	w	PO	P2	Р	tmax
330mm(13")	12mm	6.60 ± 0.10	5.30 ± 0.10	$2.10 \pm 0.10$	$1.50 \pm 0.10$	1.75 ± 0.10	5.50 ± 0.05	12.00 ± 0.30	4.00 ± 0.12	2.00 ± 0.10	8.00 ± 0.10	0.25
NOTES 1. Dimensions are	NOTES 1. Dimensions are in millimeters.											

2. Surface mount product is taped and reeled in accordance with EIA-481.

3. Marking on Part - marking code (see page 2), date code, logo and pin one defined by dot on top of package.

ORDERING INFORMATION								
BASE PART NUMBER         LEADFREE SUFFIX         TAPE SUFFIX         QTY/REEL         REEL SIZE								
PSLIC1	-LF	-T13	4,000	13″				
This device is only available in a Lead-Free configuration.								

### COMPANY INFORMATION

#### **COMPANY PROFILE**

In business more than 25 years, ProTek Devices<sup>™</sup> is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is an ISO 9001 certified company.

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